

# APPROVAL SHEET

**WR02X**

**±5%, ±1%**

General purpose chip resistors

Size 0201

Customer : \_\_\_\_\_  
Approval No : \_\_\_\_\_  
Issue Date : \_\_\_\_\_

Customer Approval :



## FEATURE

1. Small size and light weight
2. High reliability and stability
3. Reduced size of final equipment
4. Suitable for high density print circuit board assembly
5. Higher component and equipment reliability
6. Lead free product

## APPLICATION

- Mobile phone
- PDA
- Camcorders
- Palmtop computers
- Hybrid module

## DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a pure Tin.

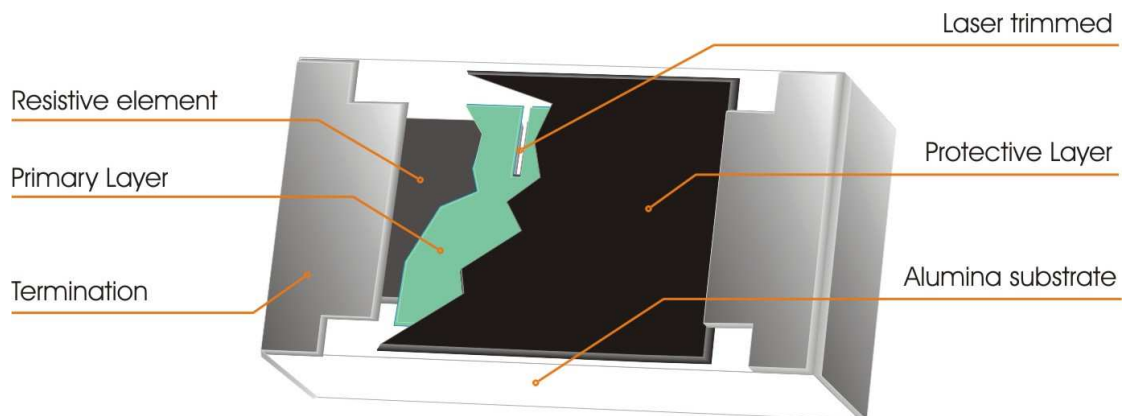


Fig 1. Construction of Chip-R WR02X

**QUICK REFERENCE DATA**

Item	General Specification	
Series No.	WR02	
Size code	0201(0603)	
Resistance Range	1Ω~10MΩ(±5%, ±1% tolerance), Jumper	
Resistance Tolerance	±1% E96/E24	±5% E24
TCR (ppm/°C)	R>1MΩ                                    1.1M - 10M, ≤±200 1MΩ > R > 10Ω                        100Ω - 1MΩ, ≤±200 10Ω > R > 10Ω                        10Ω - 97.6Ω, ≤±300 R<10Ω                                      1 - 9.76Ω, +600~-200	
Max. dissipation @ T <sub>amb</sub> =70°C	1/20 W	
Max. Operation Voltage (DC or RMS)	25V	
Max. Overload Voltage (DC or RMS)	50V	
Climatic category (IEC 60068)	55/125/56	

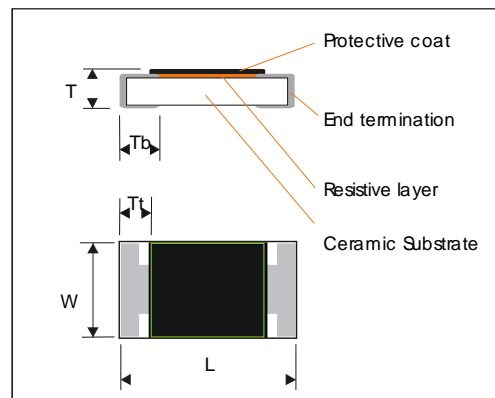
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}} \text{ or Max. RCWV listed above, whichever is lower.}$$

Dimensions:

	WR02X
<b>L</b>	0.60 ± 0.03
<b>W</b>	0.30 ± 0.03
<b>T</b>	0.23 ± 0.03
<b>Tb</b>	0.15 ± 0.05
<b>Tt</b>	0.10 ± 0.05





## Marking

WR02X has no marking.

## FUNCTIONAL DESCRIPTION

### Product characterization

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of  $\pm 5\%$  &  $\pm 1\%$ . The values of the E24/E96 series are in accordance with "IEC publication 60063"

### Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

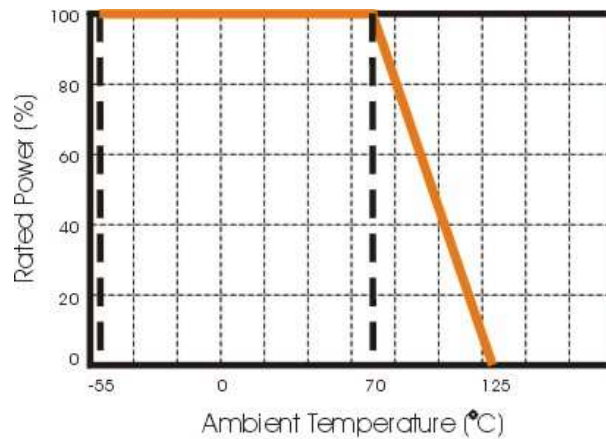


Figure 2. Maximum dissipation in percentage of rated power  
As a function of the ambient temperature

## MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

## SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 245°C during 3 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

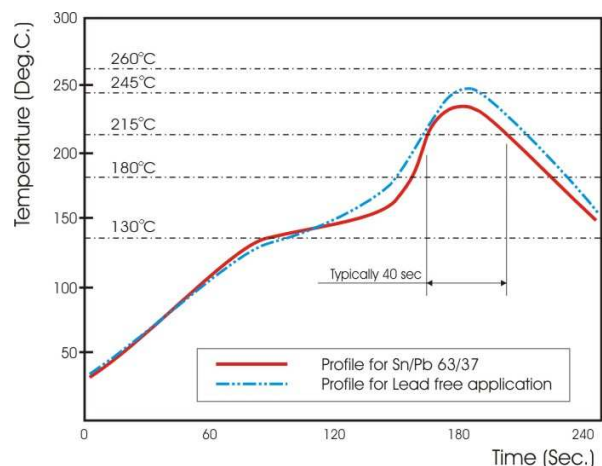


Fig 3. Infrared soldering profile for Chip Resistors WR02X

**CATALOGUE NUMBERS**

The resistors have a catalogue number starting with :

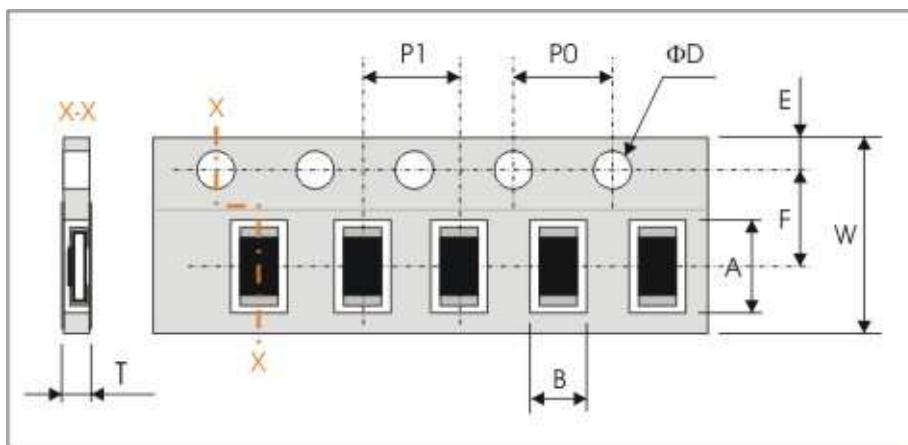
<b>WR02</b>	<b>X</b>	<b>472_</b>	<b>J</b>	<b>A</b>	<b>L</b>
<b>Size code</b> WR02 : 0201	<b>Type code</b> X : Normal	<b>Resistance code</b> E24 : 2 significant digits followed by no. of zeros and a blank 4.7Ω =4R7_ 10Ω =100_ 220Ω =221_ Jumper =000_ ("_" means a blank)	<b>Tolerance</b> J : ±5% F : ±1% P : Jumper	<b>Packaging code</b> A : 7" Reeled taping(15Kpcs/Reel)	<b>Termination code</b> L = Sn base (lead free)

## TEST AND REQUIREMENTS (JIS C 5201-1 : 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	0Ω
DC resistance <b>Clause 4.5</b>	DC resistance values measured at the test voltages specified below : <10Ω@0.1V, <100Ω@0.3V, <1KΩ@1.0V, <10KΩ@3V, <100KΩ@10V, <1MΩ@25V, <10MΩ@30V	Within the specified tolerance	<50mΩ
Temperature Coefficient of Resistance(T.C.R) <b>Clause 4.8</b>	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/}^\circ\text{C)}$ $t_1 : 20^\circ\text{C}+5^\circ\text{C}-1^\circ\text{C}$ $R_1$ : Resistance at reference temperature $R_2$ : Resistance at test temperature	Refer to "QUICK REFERENCE DATA"	N/a
Short time overload (S.T.O.L) <b>Clause 4.13</b>	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	ΔR/R max. ±(2%+0.10Ω)	<50mΩ
Resistance to soldering heat(R.S.H) <b>IEC 60068-2-58: 2004</b>	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 255°C±5°C	Δ R/R max. ±(1%+0.05Ω) no visible damage	<50mΩ
Solderability <b>IEC 60068-2-58: 2004</b>	Un-mounted chips completely immersed for 3±0.3second in a SAC solder bath at 245°C±5°C	95% coverage min., good tinning and no visible damage	
Temperature cycling <b>Clause 4.19</b>	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +125°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	ΔR/R max. ±(1%+0.05Ω)	< 50mΩ
Damp Heat (Load life in humidity) <b>Clause 4.24</b>	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	10Ω≤R<1MΩ : ΔR/R max. ±(3%+0.10Ω) R<10Ω, R≥1MΩ : ΔR/R max. ±(5%+0.10Ω)	< 50mΩ
Load Life (Endurance) <b>Clause 4.25</b>	1000+48/-0 hours; loaded with RCWV or V <sub>max</sub> in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	Ditto.	
Bending strength <b>Clause 4.33</b>	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 5mm for 10sec.	No visual damaged, ΔR/R max. ±(1%+0.05Ω)	< 50mΩ
Adhesion <b>Clause 4.32</b>	Pressurizing force: 3N, Test time: 10±1sec.	No remarkable damage or removal of the terminations	

PACKAGING

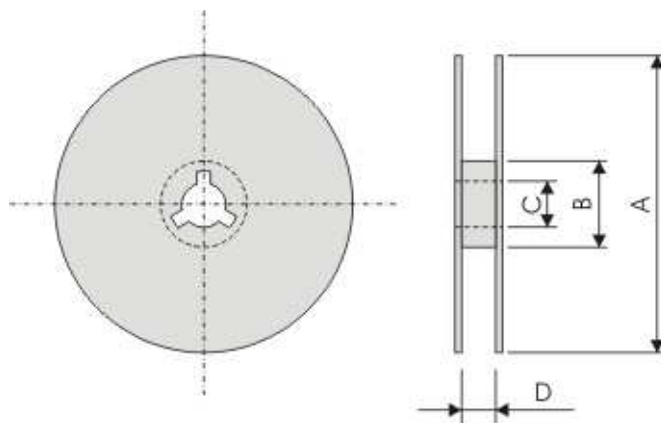
Paper Tape specifications (unit :mm)



Series No.	A	B	W	F	E
WR02X	0.67±0.05	0.37±0.05	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD	T
WR02X	2.00±0.05	4.00±0.05	Φ1.50 <sup>+0.1</sup> <sub>-0.0</sub>	0.45±0.05

Reel dimensions



Symbol	A	B	C	D
(unit : mm)	Φ180.0+0/-1.5	Φ60.0±1.0 Φ60.0+1/-0	13.0±0.2	9.0+1/-0

Taping quantity and Tape material

- Chip resistors 15,000 pcs/reel, Paper tape.

Production location in Ipoh plant , Malaysia within WTC group.